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# 2SD1012



## **Bipolar Transistor** 15V, 0.7A, Low VCE(sat), NPN Single SPA

http://onsemi.com

### **Specifications**

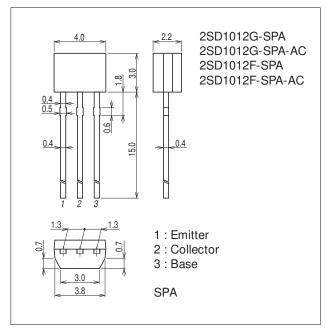
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		20	V
Collector-to-Emitter Voltage	VCEO		15	V
Emitter-to-Base Voltage	VEBO		5	V
Collector Current	IC		0.7	Α
Collector Current (Pulse)	ICP		1.5	Α
Collector Dissipation	PC		250	mW
Junction Temperature	Tj		125	°C
Storage Temperature	Tstg		-55 to +125	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

### **Package Dimensions**

unit : mm (typ) 7524-004

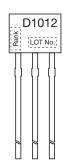


### **Product & Package Information**

Package : SPAJEITA, JEDEC : SC-72

• Minimum Packing Quantity : 2,500 pcs./box, 500pcs./bag

### Marking



### **Electrical Connection**



### 2SD1012

### **Electrical Characteristics** at Ta=25°C

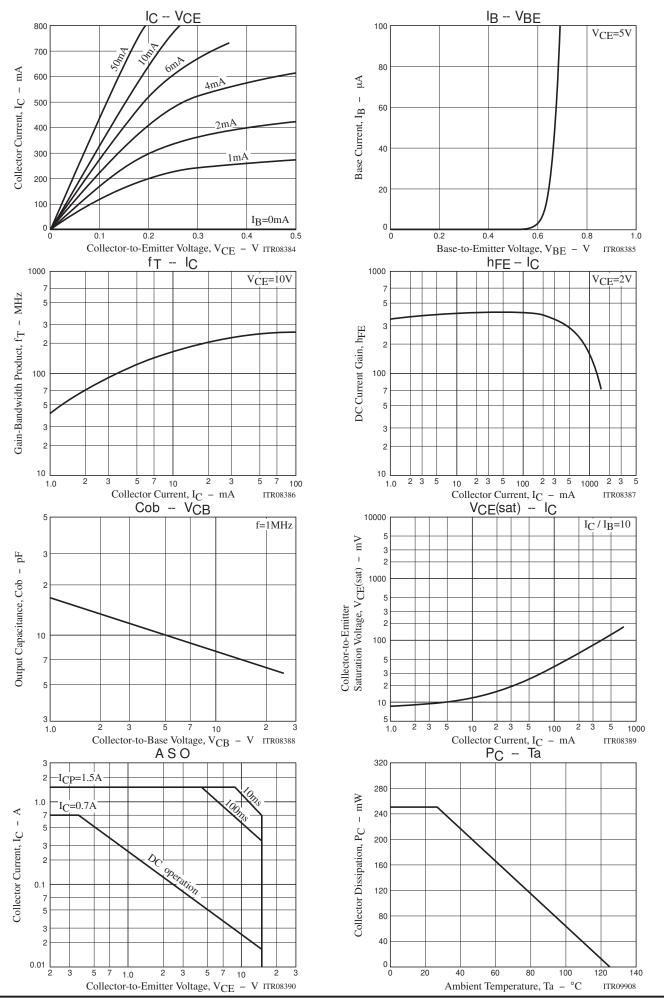
Parameter	Symbol	Conditions	Ratings			Unit	
Farameter	Syllibol	Conditions	min	typ	max	Offic	
Collector Cutoff Current	ICBO	V <sub>CB</sub> =15V, I <sub>E</sub> =0A			1.0	μΑ	
Emitter Cutoff Current	IEBO	V <sub>EB</sub> =4V, I <sub>C</sub> =0A			1.0	μΑ	
DC Current Gain	hFE1	V <sub>CE</sub> =2V, I <sub>C</sub> =50mA	160*		960*		
DC Current Gain	hFE2	V <sub>CE</sub> =2V, I <sub>C</sub> =500mA Pulse	80				
Gain-Bandwidth Product	fŢ	V <sub>CE</sub> =10V, I <sub>C</sub> =50mA		250		MHz	
Common Base Output Capacitance	Cob	V <sub>CB</sub> =10V, f=1MHz		8		pF	
Collector-to-Emitter Saturation Voltage	V <sub>CE</sub> (sat)1	I <sub>C</sub> =5mA, I <sub>B</sub> =0.5mA		10	25	mV	
Collector-to-Emitter Saturation voltage	V <sub>CE</sub> (sat)2	IC=100mA, IB=10mA		30	80	mV	
Base-to-Emitter Saturation Voltage	VBE(sat)	IC=100mA, IB=10mA		0.8	1.2	V	
Collector-to-Base Breakdown Voltage V(BI		IC=10μA, IE=0A	20			V	
Collector-to-Emitter Breakdown Voltage	V(BR)CEO	IC=1mA, RBE=∞	15			V	
Emitter-to-Base Breakdown Voltage	V(BR)EBO	I <sub>E</sub> =10μA, I <sub>C</sub> =0A	5			V	

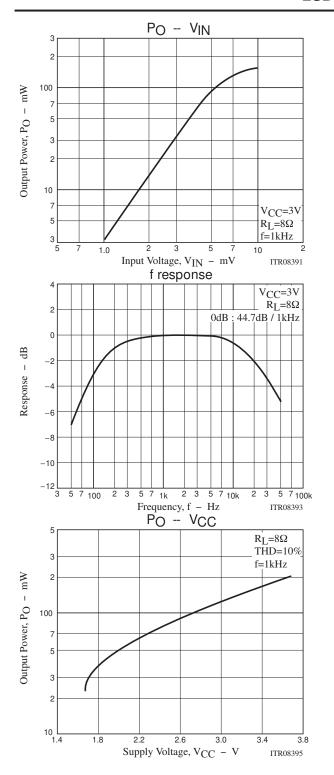
### $\mbox{\ensuremath{^{\star}}}$ : The 2SD1012 is classified by 50mA hFE as follows :

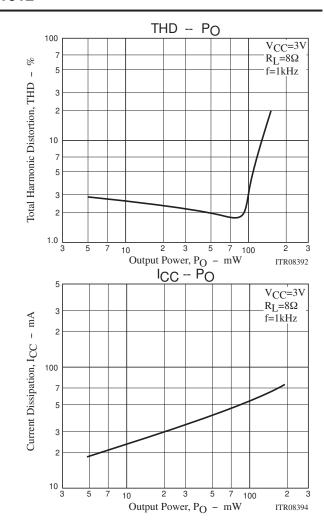
Rank	F	G	Н	
hFE	160 to 320	280 to 560	480 to 960	

### **Ordering Information**

Device	Package	Shipping	memo
2SD1012G-SPA	SPA	500pcs./bag	
2SD1012G-SPA-AC	SPA-WA	2,500pcs./box	Pb Free
2SD1012F-SPA	SPA	500pcs./bag	Pb Free
2SD1012F-SPA-AC	SPA-WA	2,500pcs./box	







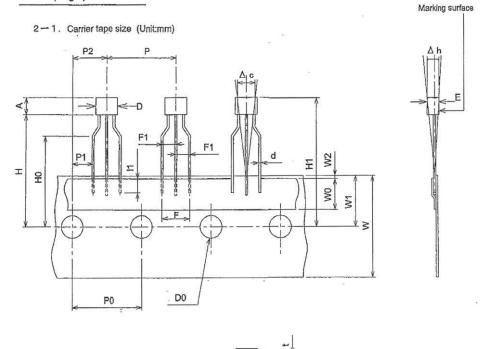
### **Taping Specification**

2SD1012G-SPA-AC, 2SD1012F-SPA-AC

Storage package Package type	Package	Maximum Numi devices containe	per of d(pcs.)	Packing format		
	Inner box No.	Storage quantity	Outer box (C-6)	Outer box (C-8)		
	AC	C-2 Inner box Dimensions :mm(external) 330 × 45 × 145	2,500	16 inner boxes contained (40,000pcs.) Outer box Dimensions:mm(external) 5 8 5 × 3 4 5 × 2 0 0	8 inner boxes contained (20,000 pcs.) Outer box Dimensions:mm(external) 3 4 5 × 3 0 0 × 2 0 0	
A	AL	C-2 Inner box Dimensions :mm(external) 330 × 45 × 145	2,400	16 inner boxes contained (38,400pcs.) Outer box Dimensions:mm(external) 5 8 5 × 3 4 5 × 2 0 0	8 inner boxes contained(19,200pcs.) Outer box Dimensions:mm(internal) 3 4 5 × 3 0 0 × 2 0 0	
	AP	C — 4 Inner box Dimensions :mm(external) 330 × 45 × 285	5,000	8 Inner boxes contained (40,000pcs.) Outer box Dimensions:mm(external) 5 8 5 × 3 4 5 × 2 0 0	4 inner boxes contained(20,000pcs.) Outer box Dimensions:mm(internal) 3 4 5 × 3 0 0 × 2 0 0	
	AS	C-2 Inner box Dimensions mm(external) 330 × 45 × 145	1,200	16 inner boxes contained(19,200 pcs.) Outer box Dimensions:mm(external) 5 8 5 × 3 4 5 × 2 0 0	8 inner boxes contained (9,600 pcs.) Outer box Dimensions:mm(intenal) 3 4 5 × 3 0 0 × 2 0 0	

# 1. Packing format Packing method Put zigzag folding in an inner box. Type No. Type No. Augustity \*\*LEAD FREE 1: Lead-free external terminal surface treatment product.

### 2. Taping specifications

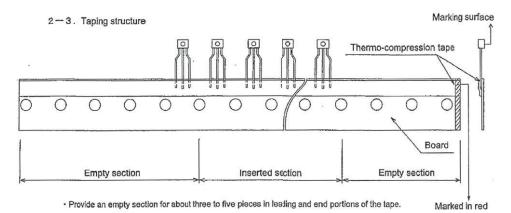


### 2-2. Taping size standard

Unit:mm	
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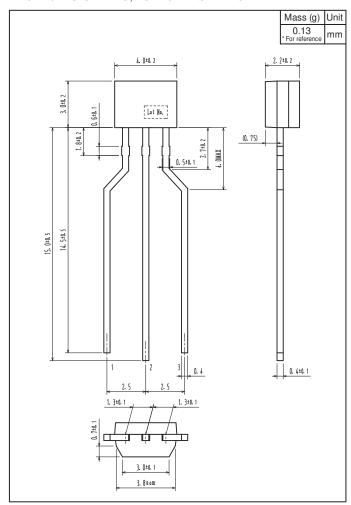
Item	Symbol	Standard	Tolerance	Item
	D	4.0	±0.2	Tape width
Work piece outside diameter	E	2.2	±0.2	Adhesive tape
Work piece height	Α	- 3.0	±0.2	Displacement of perforations
Lead wire diameter	d	0.4×0.4 t	±0.1	Work piece bottom surface position
Bonded lead wire	11	2.5MIN		Lead wire clinch height
Pitch between products	Р	12.7	±1.0	Work piece upper lmit position
Pitch between perforations	P0 .	12.7	±0.2	Perforations diameter
Total pitch for 21 perforations	P0×20	254.0	±1.0	Tape thickness (total thickness)
Distance between lead wire	F	5.0	+0.8 -0.2	Product inclination
Lead wire pitch distance	F1	2.5	+0.4	
Product inclination	Δh	0	±2.0	
Disabases of a secondary	P1	3.85	±0.3	To be measured at a position below the clinch
Displacement of perforations	P2	6.35	±0.3	
Displacement of tape	W2	0.5MAX		Not to be displaced to the outside of the board

Item	Symbol	Standard	Tolerance	
Tape width	W	18.0	+1.0 -0.5	
Adhesive tape	WO	6.0	±1.0	
Displacement of perforations	W1	9.0	+0.75	
Work piece bottom surface position	Н	19.8	+1.0 -0.3	
Lead wire clinch height	НО	16.0	±0.5	
Work piece upper lmit position	H1	22.8	±1.5	
Perforations diameter	D0	φ4.0	±0.2	
ape thickness (total thickness)	t	0.6	±0.2	
Product inclination	Δс	0	±1.0	



### **Outline Drawing**

2SD1012G-SPA-AC, 2SD1012F-SPA-AC



#### **Bag Packing Specification**

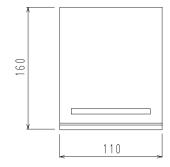
2SD1012G-SPA, 2SD1012F-SPA

### 1. Packing Format

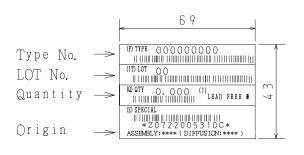
Package Name		Maximum Number of devices contained (pcs)				
	Вад	Inner	ВОХ	Outer BOX		
2.5.4		B-1	B-1/2	A-1	A-2	
SPA   500	20,000 10,000		100,000	60,000		
	•	Packing format (Dimensions:mm (external))				
		Inner BOX		Outer	ВОХ	
		B-1	B-1/2	A-1	A-2	
		445×225×55	445×225×55	470×250×300	470×250×190	

### 2. Bag dimensions

(unit:mm)

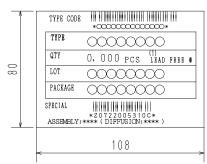


### 3. Bag label, Inner box label (unit:mm)



### 4. Outer box label (unit:mm)

It is a label at the time of factory shipments. The form of a label may change in physical distribution process.



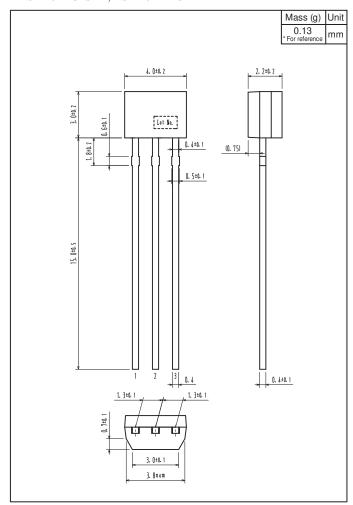
### NOTE (1)

The LEAD FREE \* description shows that the surface treatment of the terminal is lead free.

Label		JEITA Phase
LEAD FREE	3	JEITA Phase 3A
LEAD FREE	4	JEITA Phase 3

### **Outline Drawing**

2SD1012G-SPA, 2SD1012F-SPA



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